

Ultrafast Soft Recovery Diode, 60 A FRED Pt® Gen 4



| PRIMARY CHARACTERISTICS | | | | | | |
|----------------------------------|--------------------|--|--|--|--|--|
| I _{F(AV)} | 60 A | | | | | |
| V_{R} | 600 V | | | | | |
| V _F at I _F | 1.29 V | | | | | |
| t _{rr} typ. | see Recovery table | | | | | |
| T _J max. | 175 °C | | | | | |
| Package | TO-247AD 2L | | | | | |
| Circuit configuration | Single | | | | | |

FEATURES

- Gen 4 FRED Pt® technology
- Low I_{RBM} and reverse recovery charge
- · Very low forward voltage drop
- Polyimide passivated chip for high reliability standard



- 175 °C operating junction temperature
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION

Gen 4 Fred technology, state of the art, ultralow V_F , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

| ABSOLUTE MAXIMUM RATINGS | | | | | | | |
|--|-----------------------------------|--|-------------|-------|--|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS | | | |
| Peak repetitive reverse voltage | V _{RRM} | | 600 | V | | | |
| Average rectified forward current | I _{F(AV)} | T _C = 116 °C | 60 | ۸ | | | |
| Non-repetitive peak surge current | I _{FSM} | $T_C = 25$ °C, $t_p = 8.3$ ms half sine wave | 450 | A | | | |
| Operating junction and storage temperature | T _J , T _{Stg} | | -55 to +175 | °C | | | |

| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | | | |
|--|--------------------|--|-----|------|------|-------|--|--|
| PARAMETER | SYMBOL | BOL TEST CONDITIONS | | TYP. | MAX. | UNITS | | |
| Breakdown voltage, blocking voltage | V_{BR} , V_{R} | I _R = 100 μA | 600 | - | - | | | |
| Forward voltage | | I _F = 30 A | - | 1.4 | - | V | | |
| | V _F | I _F = 60 A | - | 1.46 | 1.7 | | | |
| | | I _F = 30 A, T _J = 125 °C | - | 1.26 | - | | | |
| | | I _F = 60 A, T _J = 125 °C | - | 1.33 | - | | | |
| | | I _F = 30 A, T _J = 150 °C | - | 1.22 | - | | | |
| | | I _F = 60 A, T _J = 150 °C | - | 1.29 | - | | | |
| Reverse leakage current | I _R | V _R = V _R rated | - | - | 50 | | | |
| | | T _J = 125 °C, V _R = V _R rated | - | - | 500 | μA | | |
| Junction capacitance | C _T | V _R = 600 V | - | 30 | - | pF | | |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | | |
|---|---------------------------------------|-------------------------|--|---|------|---|-------|--|
| PARAMETER | SYMBOL TEST CONDITIONS MIN. TYP. MAX. | | | | | | UNITS | |
| Poverse receives time | t _{rr} | T _J = 25 °C | I _F = 60 A dI _F /dt = 1000 A/μs V _R = 400 V | - | 74 | - | ns | |
| Reverse recovery time | | T _J = 125 °C | | - | 105 | - | | |
| Peak recovery current | I _{RRM} | T _J = 25 °C | | - | 31 | - | Α | |
| | | T _J = 125 °C | | - | 50 | - | | |
| Reverse recovery charge | Q _{rr} | T _J = 25 °C | | - | 1530 | - | 200 | |
| | | T _J = 125 °C | | - | 3520 | - | nC | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | | | |
|---|-------------------|------------------------|------------|------|------------|------------------------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | | |
| Thermal resistance, junction to case | R _{thJC} | | - | - | 0.6 | | | |
| Thermal resistance, junction to ambient | R _{thJA} | Typical socket mount | - | - | 40 | °C/W | | |
| Thermal resistance, case to heatsink | R _{thCS} | | - | 0.25 | - | | | |
| Weight | | | - | 6.0 | - | g | | |
| Weight | | | - | 0.21 | - | oz. | | |
| Mounting torque | | | 6.0 (5) | - | 12 (20) | kgf · cm (lbf · in) | | |
| Marking device | | Case style TO-247AD 2L | E4PU6006L | | | • | | |

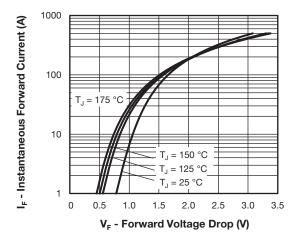


Fig. 1 - Typical Forward Voltage Drop Characteristics

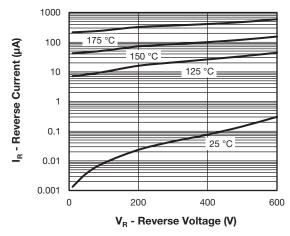


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

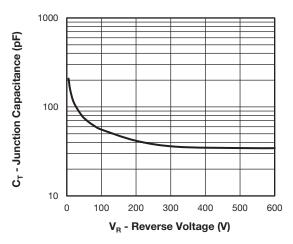


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

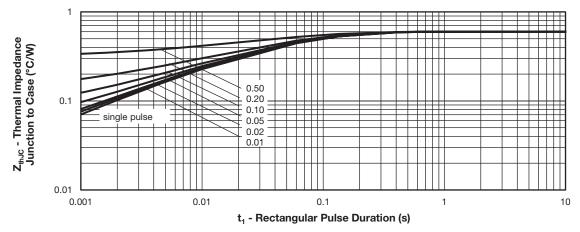


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics

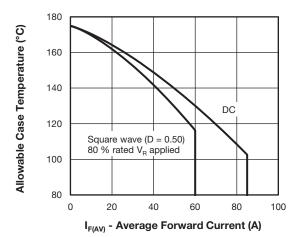


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

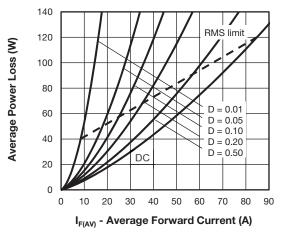
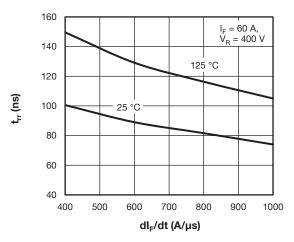


Fig. 6 - Forward Power Loss Characteristics

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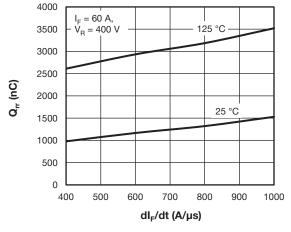


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

Fig. 8 - Typical Stored Charge vs. dl_F/dt

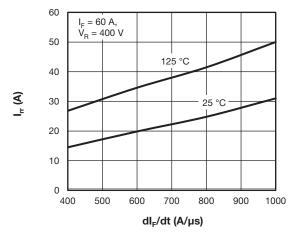
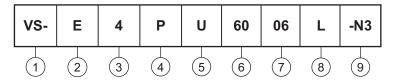


Fig. 9 - Typical Reverse Current vs. dl_F/dt



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Circuit configuration:

E = single diode

3 - FRED Gen 4

- P = TO-247 package

5 - Process type:

U = ultrafast recovery

6 - Current rating (60 = 60 A)

7 - Voltage rating (06 = 600 V)

8 - L = long lead

9 - Environmental digit:

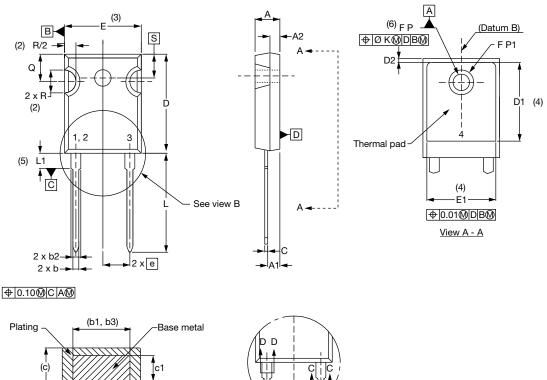
-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

| ORDERING INFORMATION (Example) | | | | | | | |
|--|----|-----|-------------------------|--|--|--|--|
| PREFERRED P/N QUANTITY PER TUBE MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION | | | | | | | |
| VS-E4PU6006L-N3 | 25 | 500 | Antistatic plastic tube | | | | |

| LINKS TO RELATED DOCUMENTS | | | | | |
|--|--------------------------|--|--|--|--|
| Dimensions <u>www.vishay.com/doc?95536</u> | | | | | |
| Part marking information | www.vishay.com/doc?95648 | | | | |

TO-247AD 2L

DIMENSIONS in millimeters and inches



| D D C C |
|---------------|
| <u>View B</u> |

| SYMBOL | MILLIN | IETERS | INC | HES | NOTES |
|----------|--------|--------|-------|-------|-------|
| STIVIDOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.65 | 5.31 | 0.183 | 0.209 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | |
| С | 0.38 | 0.89 | 0.015 | 0.035 | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 |
| D1 | 13.08 | - | 0.515 | - | 4 |
| D2 | 0.51 | 1.35 | 0.020 | 0.053 | |

| SYMBOL | MILLIMETERS | | INC | NOTES | |
|---------|-------------|-------|-------|-------|-------|
| STWIDOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Е | 15.29 | 15.87 | 0.602 | 0.625 | 3 |
| E1 | 13.46 | - | 0.53 | - | |
| е | 5.46 | BSC | 0.215 | BSC | |
| ØK | 0.2 | 0.254 | | 0.010 | |
| L | 19.81 | 20.32 | 0.780 | 0.800 | |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 | |
| ØΡ | 3.56 | 3.66 | 0.14 | 0.144 | |
| Ø P1 | - | 6.98 | - | 0.275 | |
| Q | 5.31 | 5.69 | 0.209 | 0.224 | |
| R | 4.52 | 5.49 | 0.178 | 0.216 | |
| S | 5.51 BSC | | 0.217 | BSC | |
| | | | | | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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